PD-96007B

International

IRC730PbF

 $V_{DSS} = 400V$

 $R_{DS(on)} = 1.0\Omega$

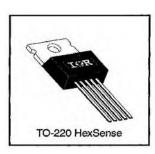
HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Current Sense
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The HEXSense device provides an accurate fraction of the drain current through the additional two leads to be used for control or protection of the device. These devices exhibit similar electrical and thermal characteristics as their IRF-series equivalent part numbers. The provision of a kelvin source connection effectively eliminates problems of common source inductance when the HEXSense is used as a fast, high-current switch in non current-sensing applications.



 $I_{D} = 5.5A$

Absolute Maximum Ratings

	Parameter	Max.	Units	
$I_{D} @ T_{C} = 25^{\circ}C$	Continuous Drain Current, VGS @ 10 V	5.5		
ID @ Tc = 100°C	Continuous Drain Current, VGs @ 10 V	3.5	A	
IDM	Pulsed Drain Current ①	22		
P _D @ T _C = 25°C	Power Dissipation	74	W	
	Linear Derating Factor	0.59	W/°C	
Vgs	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy @	130	mJ	
IAR	Avalanche Current ①	5.5	A	
EAR	Repetitive Avalanche Energy ①	7.4	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	4.0	V/ns	
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf-in (1.1 N-m)		

D

G

Kelvin

Source

Current

Sense

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
Rejc	Junction-to-Case	-	-	1.0	
Recs	Case-to-Sink, Flat, Greased Surface	-	0.50		°C/W
Reja	Junction-to-Ambient	_		62	

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	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	400	-	-	V	V _{GS} =0V, I _D = 250µA	
AV(BR)DSS/ATJ	Breakdown Voltage Temp. Coefficient	-	0.54	-	V/°C	Reference to 25°C, Ip= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	-	-	1.0	Ω	Vgs=10V, Ip=3.3A @	
VGS(th)	Gate Threshold Voltage	2.0	-	4.0	٧	VDS=VGS, ID= 250µA	
g fs	Forward Transconductance	2.4	-	-	S	VDS=50V, ID=3.3A @	
IDSS	Drain to Source Lookage Current	0-0	_	25		V _{DS} =400V, V _{GS} =0V	
	Drain-to-Source Leakage Current	-	-	250	μA	VDS=320V, VGS=0V, TJ=125°C	
	Gate-to-Source Forward Leakage	-	-	100	nA	V _{GS} =20V	
IGSS	Gate-to-Source Reverse Leakage	-	-	-100	U/A	V _{GS} =-20V	
Qg	Total Gate Charge	-	-	38		ID=3.7A	
Q _{gs}	Gate-to-Source Charge	-	-	5.7	nC	V _{DS} =320V V _{GS} =10V See Fig. 6 and 13 @	
Q _{gd}	Gate-to-Drain ("Miller") Charge	-	-	22			
td(on)	Turn-On Delay Time	-	18	-		V _{DD} =200V	
tr	Rise Time	-	15		ns	I _D =3.7A Rg=12Ω	
td(off)	Turn-Off Delay Time	-	38	_	1.0		
tr	Fall Time	-	14	-		R _D =36Ω See Figure 10 @	
LD	Internal Drain Inductance	1	4.5	-	nH	Between lead, 6 mm (0.25in.) from package and center of die contact	
Ls	Internal Source Inductance	-	7.5	-			
Ciss	Input Capacitance	-	700	-		V _{GS} =0V	
Coss	Output Capacitance	-	170	-	pF	V _{DS} =25V	
Crss	Reverse Transfer Capacitance	-	64	-		f=1.0MHz See Figure 5	
r	Current Sensing Ratio	1450	-	1600	-	I _D =5.5A, V _{GS} =10V	
Coss	Output Capacitance of Sensing Cells	-	9.0	-	pF	V _{GS} =0V, V _{DS} = 25V, f=1.0MHz	

Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

1	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	-	-	5.5	A	MOSFET symbol showing the
ISM	Pulsed Source Current (Body Diode) ①	-	-	22		integral reverse Guing Current p-n junction diode.
VSD	Diode Forward Voltage	-	-	1.6	V	TJ=25°C, IS=5.5A, VGS=0V @
trr	Reverse Recovery Time	-	260	530	ns	T_=25°C, I==3.7A
Qrr	Reverse Recovery Charge	-	1.2	2.2	μC	di/dt=100A/µs ④
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)				

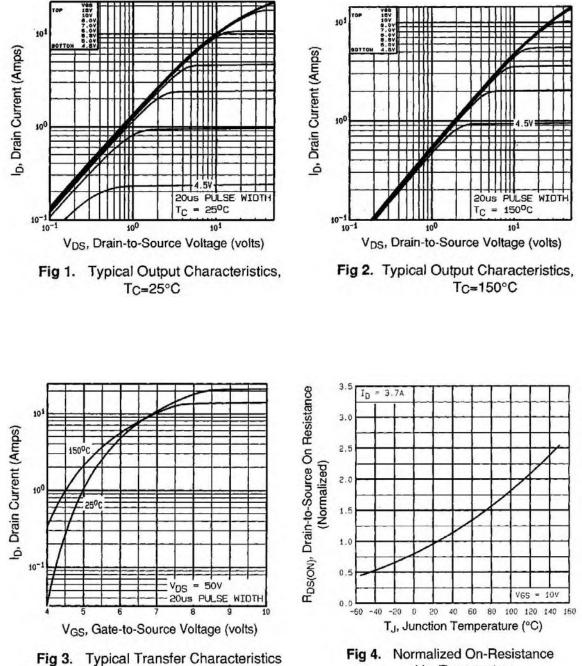
Notes:

 Repetitive rating; pulse width limited by max. junction temperature (See Figure 11) ③ I_{SD}≤5.5A, di/dt≤75A/ μ s, V_{DD}≤V(BR)DSS, T_J≤150°C

- ② V_{DD}=50V, starting T_J=25°C, L=7.50mH R_G=25Ω, I_{AS}=5.5A (See Figure 12)
- ④ Pulse width \leq 300 µs; duty cycle \leq 2%.

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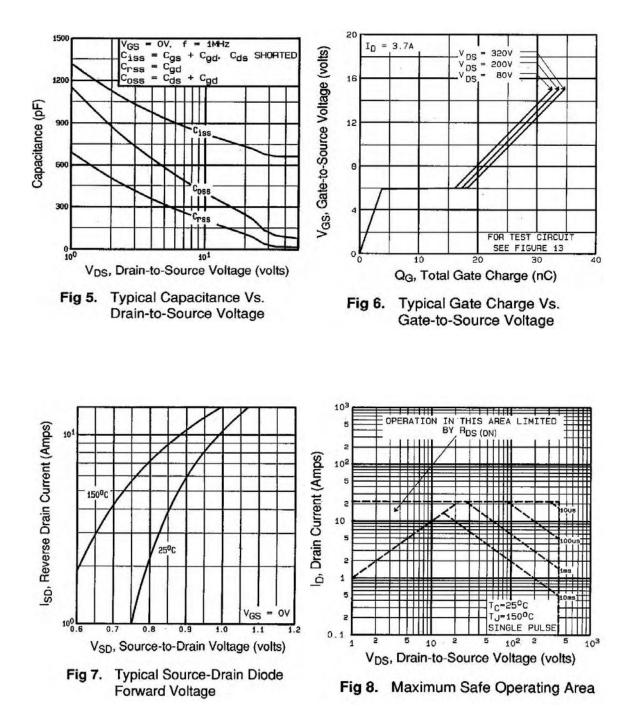
International



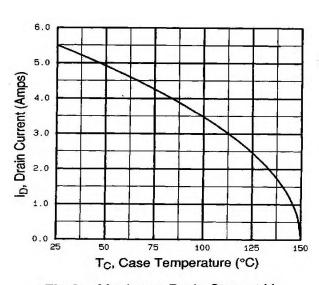
Vs. Temperature

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Fig 9. Maximum Drain Current Vs. Case Temperature

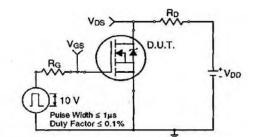


Fig 10a. Switching Time Test Circuit

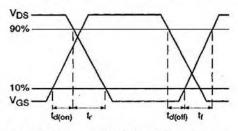


Fig 10b. Switching Time Waveforms

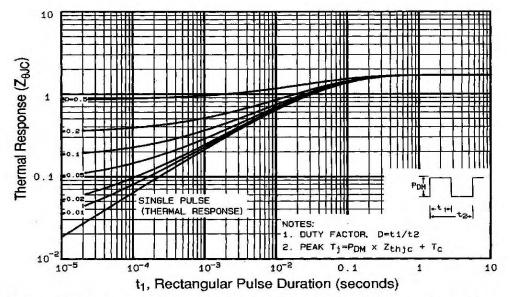
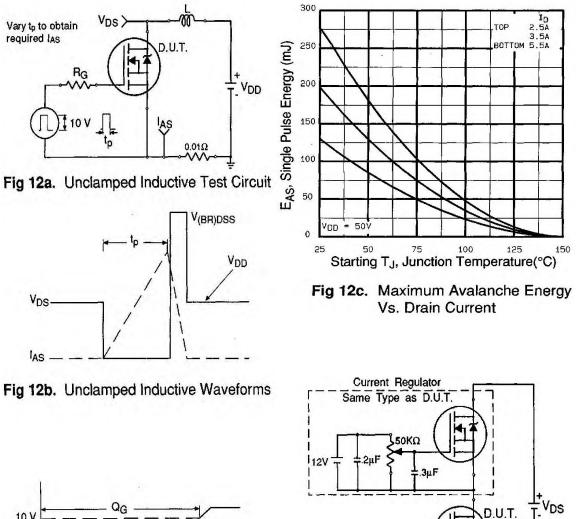
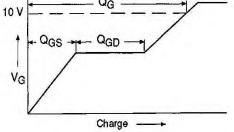


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

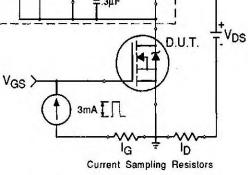
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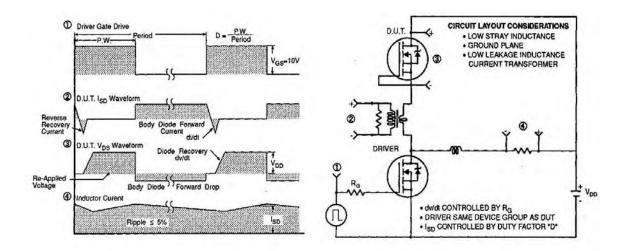
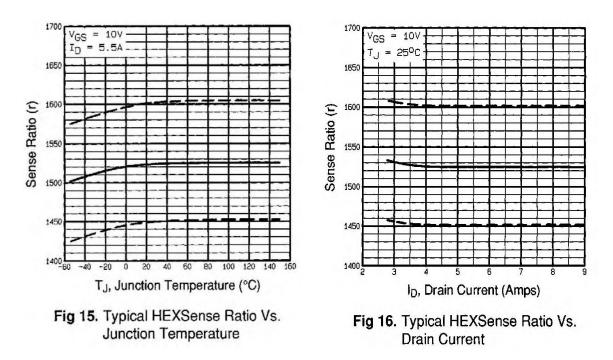
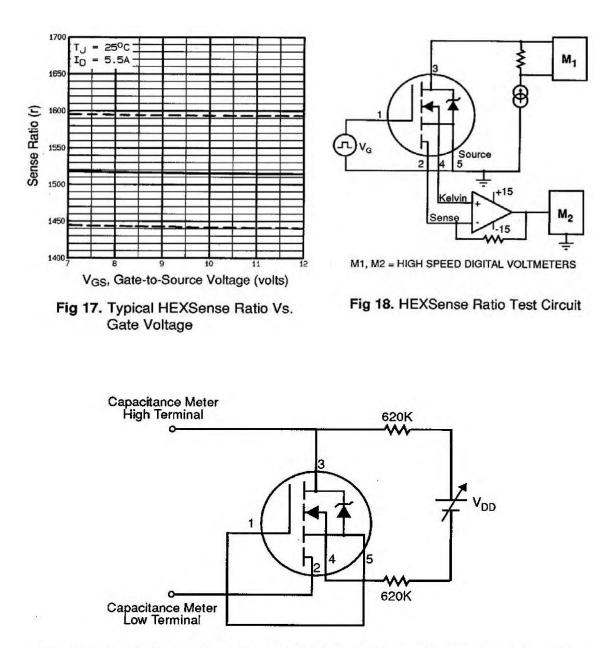


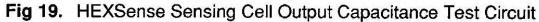
Fig 14. Peak Diode Recovery dv/dt Test Circuit



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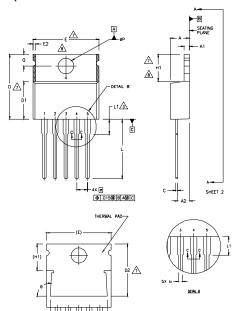
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International **TER** Rectifier

IRC730PbF

HexsenseTO-220 5L Package Outline

(Dimensions are shown in millimeters (inches)



A

NOTES: DIMENSIONING AND TOLERANCING PER ASME Y14,5 M- 1994.

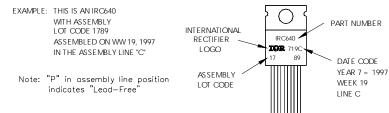
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- DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. DIMENSIONS ARE SHOWN IN INCHES MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1. DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED. 005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. DIMENSION 1 & c1 APPLY TO BASE METAL ONLY. CONTROLLING DIMENSION : INCHES. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,1,1,D2 & E1 DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED.

SYMBOL	MILLIM	ETERS	INCHES		
	Min.	MAX.	MIN.	MAX.	NOTES
A	3.56	4.82	,140	.190	
A1	0.51	1.40	.020	.055	
A2	2.04	2.92	.080	.115	
b	0.64	0.88	.025	.035	
b1	0.64	0.84	.025	.033	5
с	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16.51	.560	.650	4
D1		9.02			4
-	8.38		.330	.355	7
D2	12.19	12.88	.480	.507	
E	9.66	10.66	.380	.420 .350	4,7 7
E1	8,38	8.89	.330	/	
e		BSC		BSC	7.0
H1	5.85	6,55	.230	.270	7,8
L	13,47	14,09	.530	.555	3
L1	-	6,35	-	.250	3
øP	3.54	4.08	.139	.161	
Q	2.54	3.42	,100	.135	
ø	90'-	-93	90'-	-93	

Hexsense TO-220 5L Part Marking Information

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Data and specifications subject to change without notice.

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